

FK3906010L

Silicon N-channel MOSFET

For switching

FK350601 in SSMini3 type package

■ Features

- Low drive voltage: 2.5 V drive
- Halogen-free / RoHS compliant
(EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

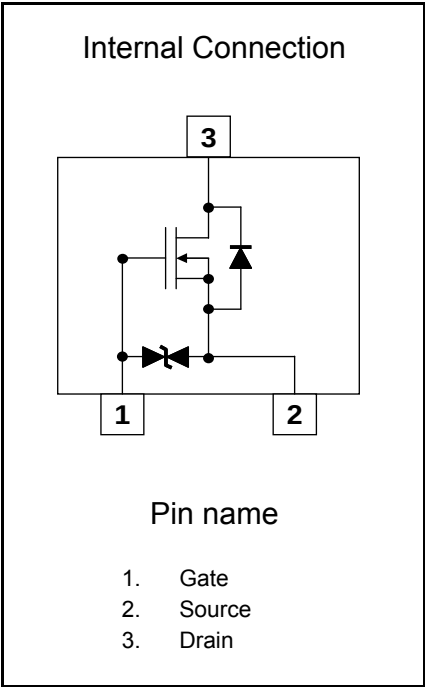
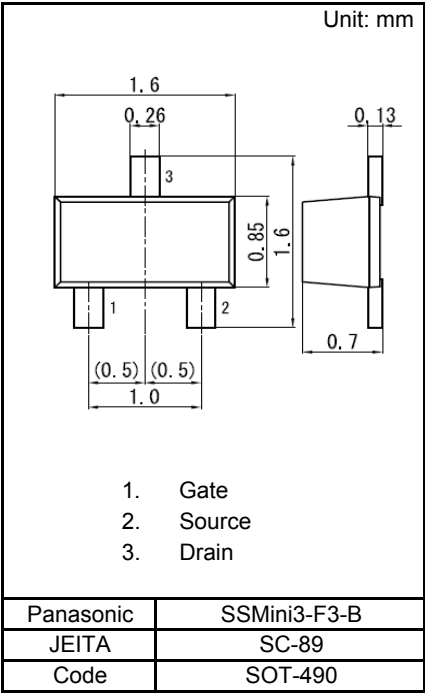
■ Marking Symbol: CV

■ Packaging

FK3906010L Embossed type (Thermo-compression sealing):
3 000 pcs / reel (standard)

■ Absolute Maximum Ratings Ta = 25 °C

Parameter	Symbol	Rating	Unit
Drain-source Voltage	VDS	60	V
Gate-source Voltage	VGS	±12	V
Drain Current	ID	100	mA
Drain Current(Pulsed)	IDp	200	mA
Total Power Dissipation	PD	125	mW
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C



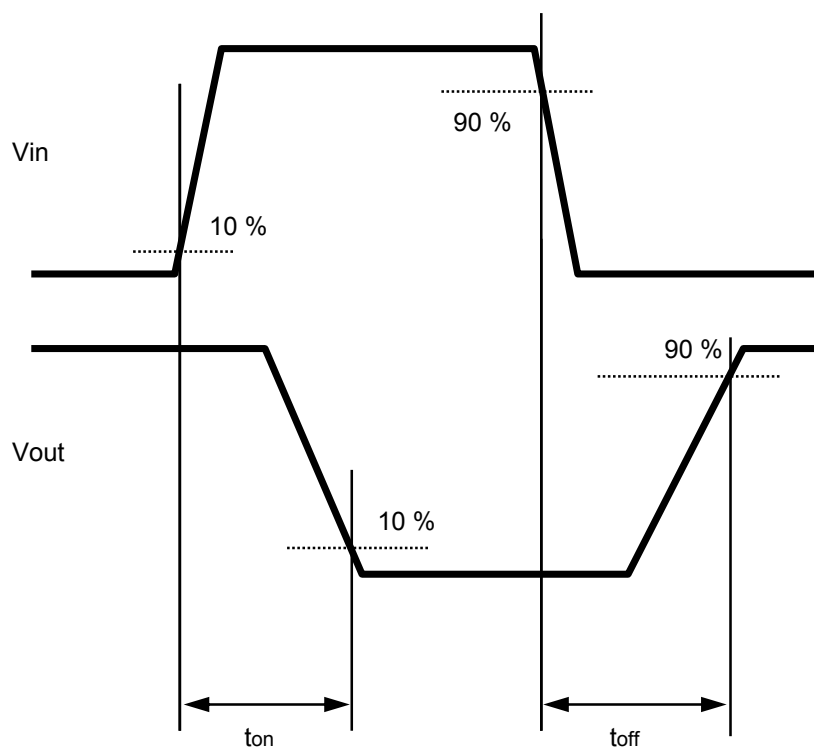
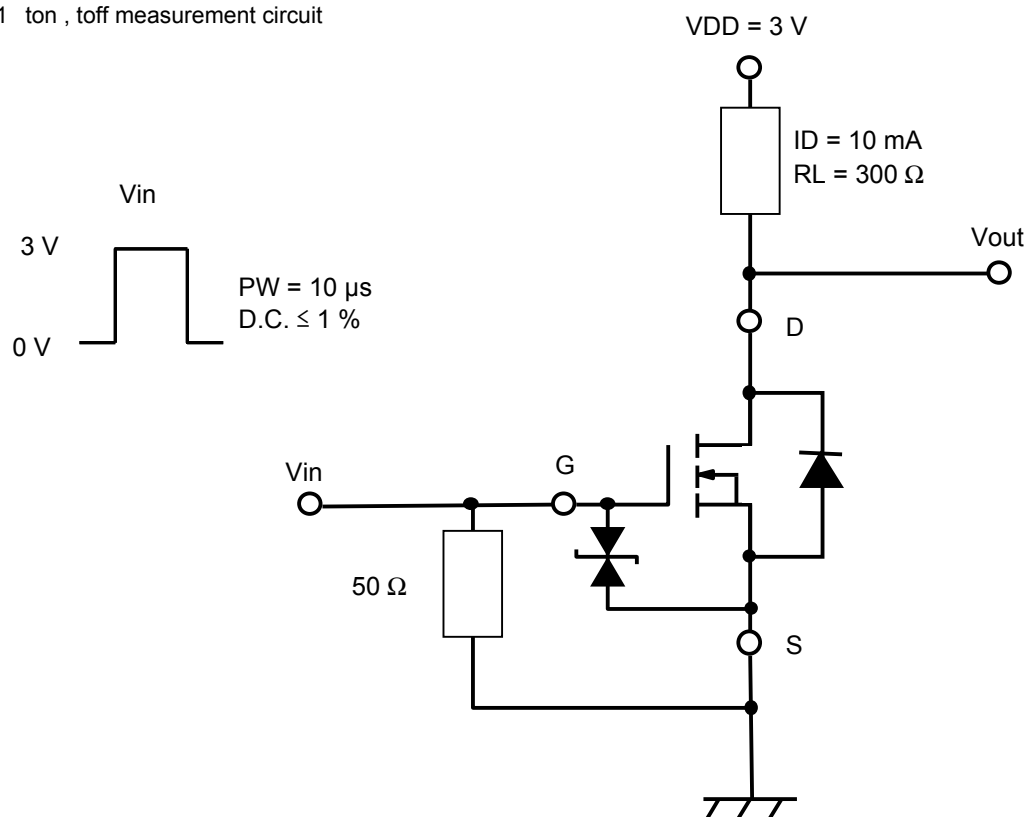
■ Electrical Characteristics Ta = 25 °C ± 3 °C

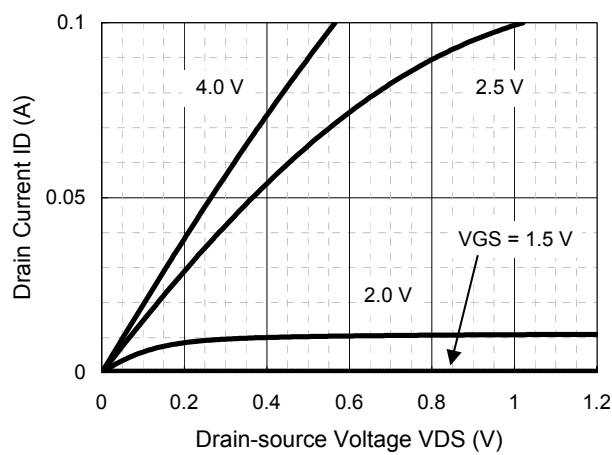
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Drain-source Breakdown Voltage	VDSS	ID = 1 mA, VGS = 0 V	60			V
Zero Gate Voltage Drain Current	IDSS	VDS = 60 V, VGS = 0 V			1.0	μA
Gate-source Leakage Current	IGSS	VGS = ±10 V, VDS = 0 V			±10	μA
Gate-source Threshold Voltage	Vth	ID = 1.0 μA, VDS = 3 V	0.9	1.2	1.5	V
Drain-source On-state Resistance	RDS(on)1	ID = 10 mA, VGS = 2.5 V		8	15	Ω
	RDS(on)2	ID = 10 mA, VGS = 4.0 V		6	12	
Forward Transfer Admittance	Yfs	ID = 10 mA, VDS = 3 V, f = 1 kHz	20	60		mS
Input Capacitance	Ciss	VDS = 3 V, VGS = 0 V, f = 1 MHz		12		pF
Output Capacitance	Coss			7		
Reverse Transfer Capacitance	Crss			3		
Turn-on Time *1	ton	VDD = 3 V, VGS = 0 to 3 V, ID = 10 mA		100		ns
Turn-off Time *1	toff	VDD = 3 V, VGS = 3 to 0 V, ID = 10 mA		100		

Note: Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 Measuring methods for transistors.

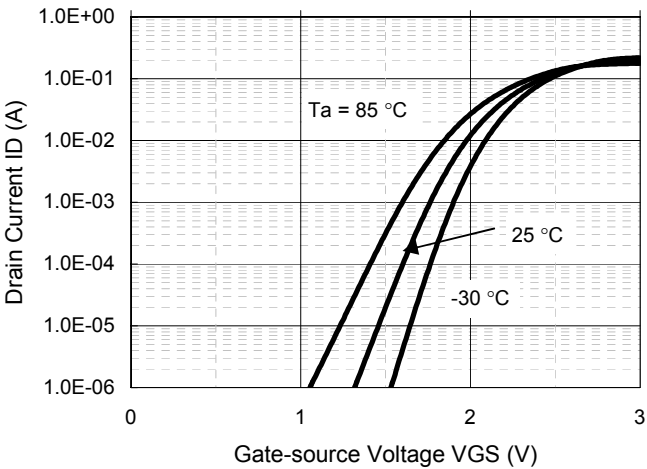
*1 ton , toff measurement circuit

*1 t_{on} , t_{off} measurement circuit

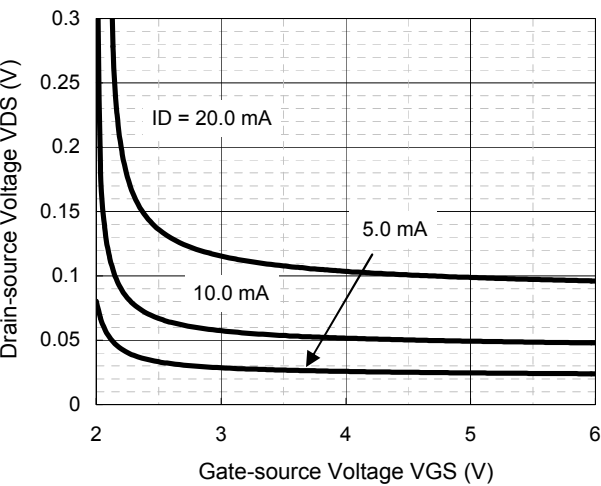




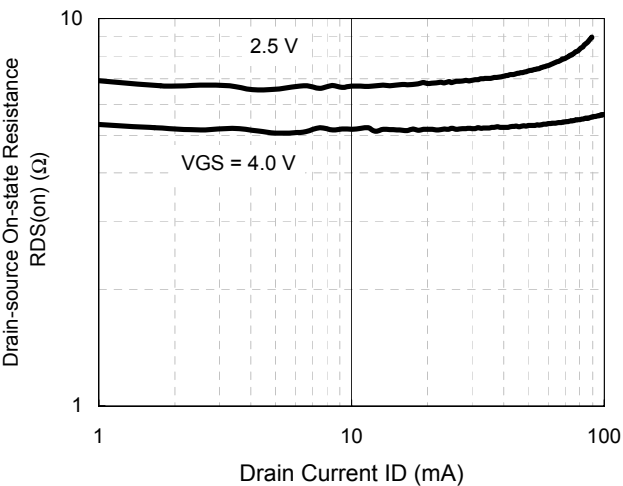
ID - VDS



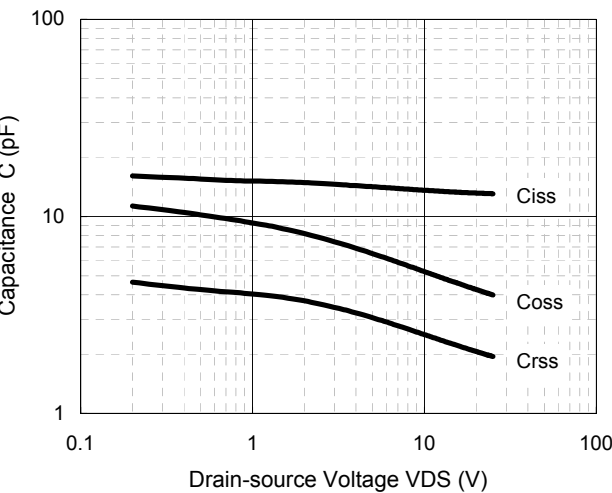
ID - VGS



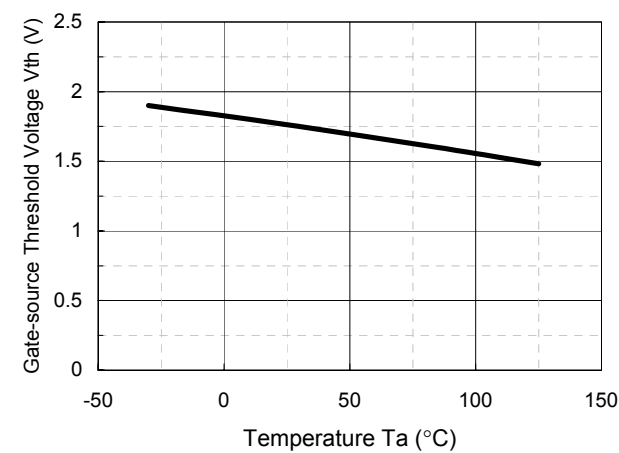
VDS - VGS



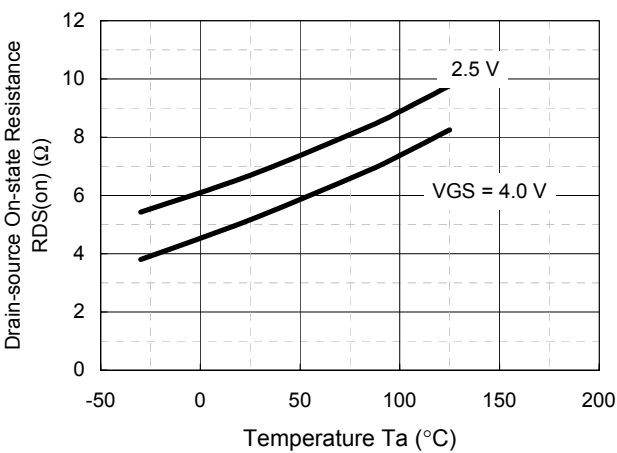
RDS(on) - ID



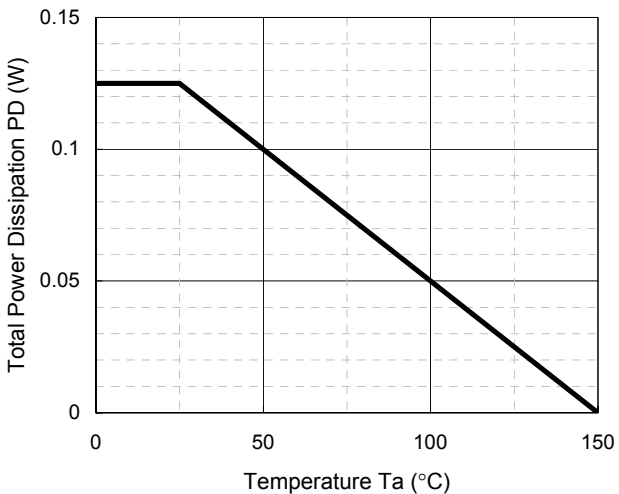
Capacitance - VDS



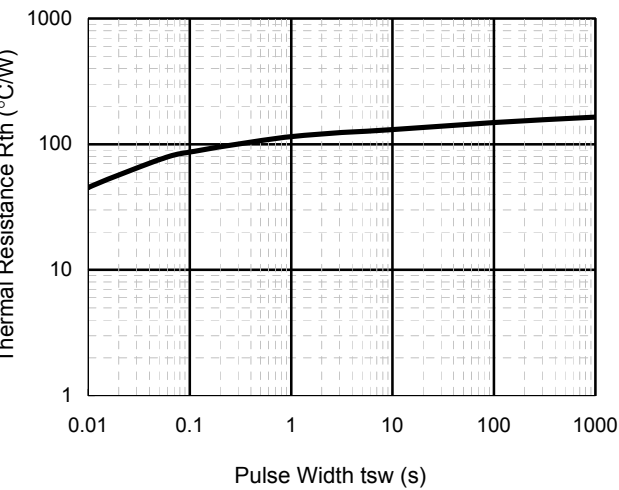
V_{th} - T_a



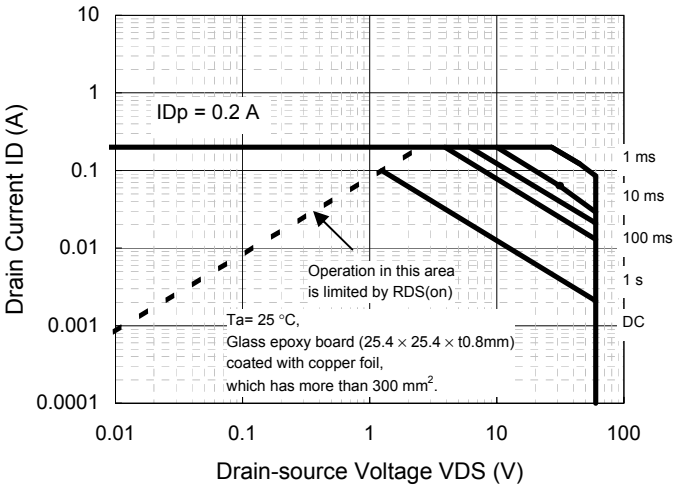
$R_{DS(on)}$ - T_a



P_D - T_a



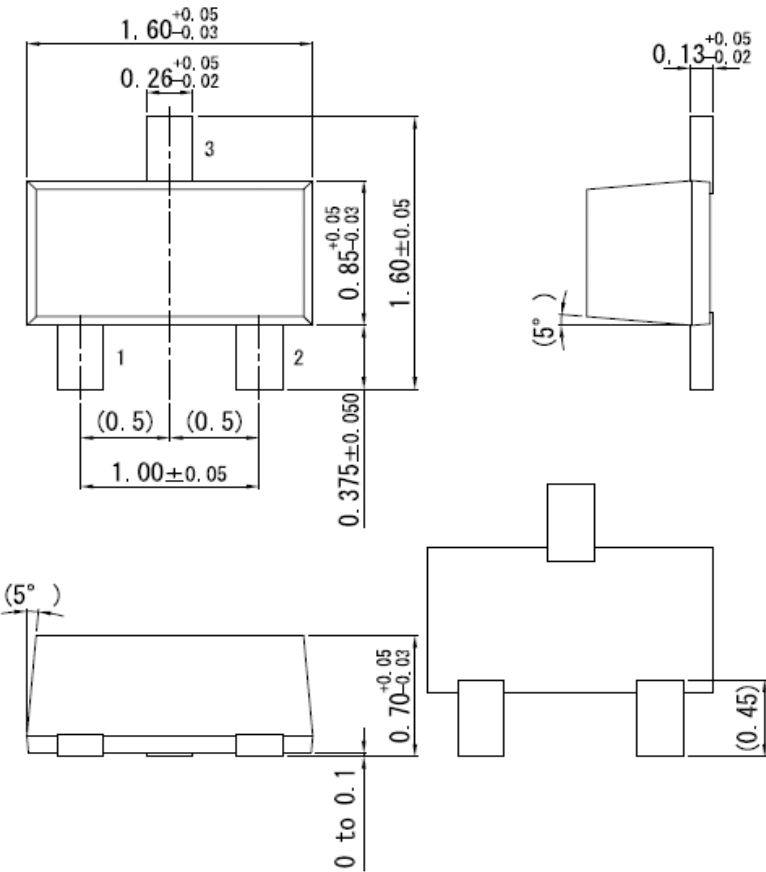
R_{th} - t_{sw}



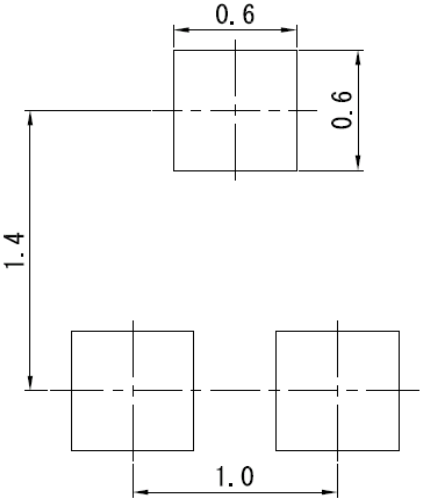
Safe Operating Area

SSMini3-F3-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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